

RoHS

COMPLIANT

HALOGEN

FREE Available

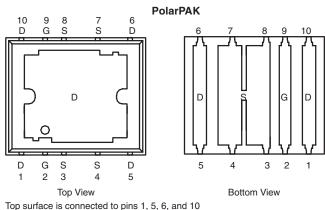
Vishay Siliconix

N-Channel 40-V (D-S) MOSFET

PRODU	PRODUCT SUMMARY					
		I _D (A) ^a				
V _{DS} (V)	R_{DS(on)} (Ω)	Silicon Limit	Package Limit	Q _g (Typ.)		
40	0.0055 at V_{GS} = 10 V	103	50	25 nC		
40	0.007 at V _{GS} = 4.5 V	91	50	25110		

Package Drawing

www.vishay.com/doc?73398

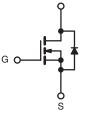


FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{gd}/Q_{gs} Ratio Helps Prevent Shoot-Through
- 100 % R_g and UIS Tested
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- VRM
- Point-of-Load
- Synchronous Rectification



D

N-Channel MOSFET For Related Documents

www.vishav.com/ppg?74414

Ordering Information: SiE832DF-T1-E3 (Lead (Pb)-free)

ing Information: SiE832DF-T1-E3 (Lead (Pb)-free) SiE832DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		103 (Silicon Limit)		
	10 - 20 0		50 ^a (Package Limit)		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _C = 70 °C	I _D	50 ^a		
	T _A = 25 °C		23.6 ^{b, c}		
	T _A = 70 °C]	18.9 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	80		
Continuous Source-Drain Diode Current	T _C = 25 °C		50 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.3 ^{b, c}		
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	35		
Avalanche Energy		E _{AS}	61	mJ	
	T _C = 25 °C		104		
Maximum Power Dissipation	T _C = 70 °C	PD	66	w	
	T _A = 25 °C	טי	5.2 ^{b, c}	••	
	T _A = 70 °C] [3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260	U U	

Notes:

a. Package limited is 50 A.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (<u>www.vishay.com/doc?73257</u>). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	20	24	
Maximum Junction-to-Case (Drain Top) ^a	Steady State	R _{thJC} (Drain)	1	1.2	°C/W
Maximum Junction-to-Case (Source) ^{a, c}	Sleady State	R _{thJC} (Source)	2.8	3.4	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Maximum under Steady State conditions is 68 °C/W.

c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	1 050 4		43.1		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.9		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.5	2.2	3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	25			А
	D	V _{GS} = 10 V, I _D = 14 A		0.0046	0.0055	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$		0.0058	0.007	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 13.6 A		86		S
Dynamic ^b				•		
Input Capacitance	C _{iss}			3800		
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		510		pF
Reverse Transfer Capacitance	C _{rss}			160		
Tatal Cata Charge	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		51	77	
Total Gate Charge				25	38	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		12		nC
Gate-Drain Charge	Q _{gd}			7		
Gate Resistance	R _g	f = 1 MHz		1.1	1.7	Ω
Turn-On Delay Time	t _{d(on)}			45	70	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		260	400	
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}\cong$ 10 A, ${ m V}_{ m GEN}$ = 4.5 V, ${ m R}_{ m g}$ = 1 Ω		35	55	
Fall Time	t _f	-		55	85	
Turn-On Delay Time	t _{d(on)}			15	25	ns
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		30	45	113
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}\cong$ 10 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 Ω		35	55	
Fall Time	t _f	-		10	15	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			50	А
Pulse Diode Forward Current ^a	I _{SM}				80	A
Body Diode Voltage	V _{SD}	I _S = 10 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			85	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		110	170	nC
Reverse Recovery Fall Time	t _a	$F = 10 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}, 1\text{ J} = 25 \text{ C}$		64		20
Reverse Recovery Rise Time	t _b			21		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

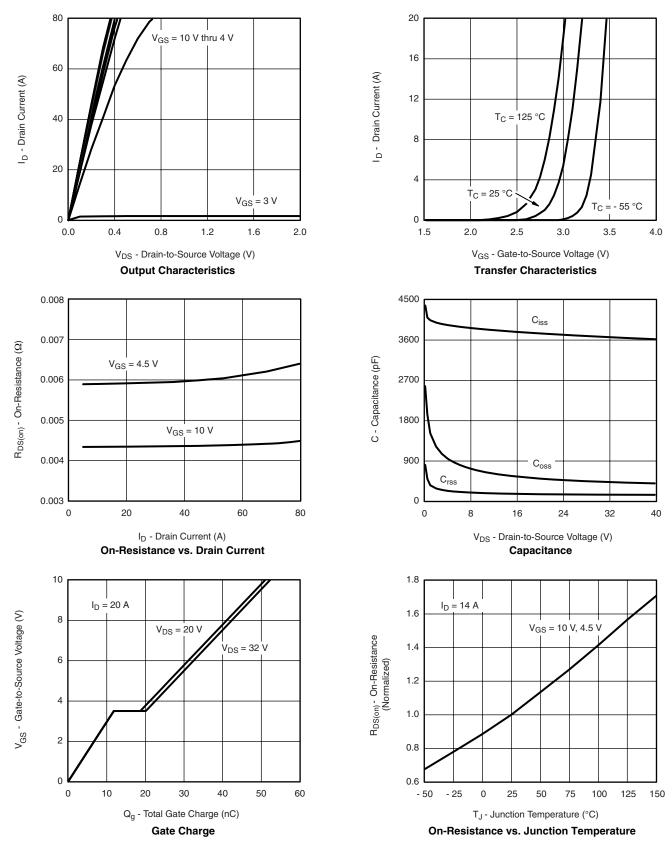
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



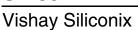
SiE832DF Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



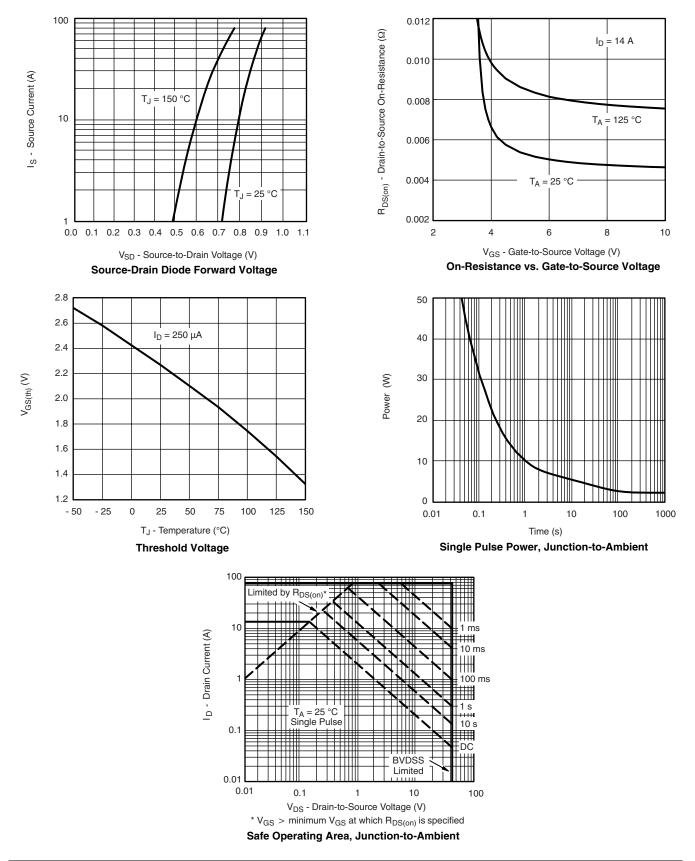
Document Number: 74414 S09-1338-Rev. C, 13-Jul-09

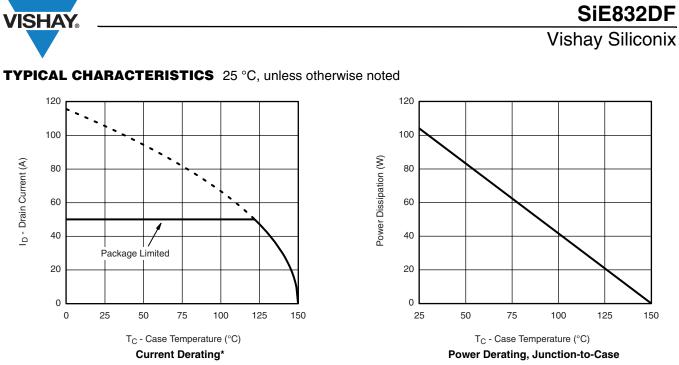
SiE832DF





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





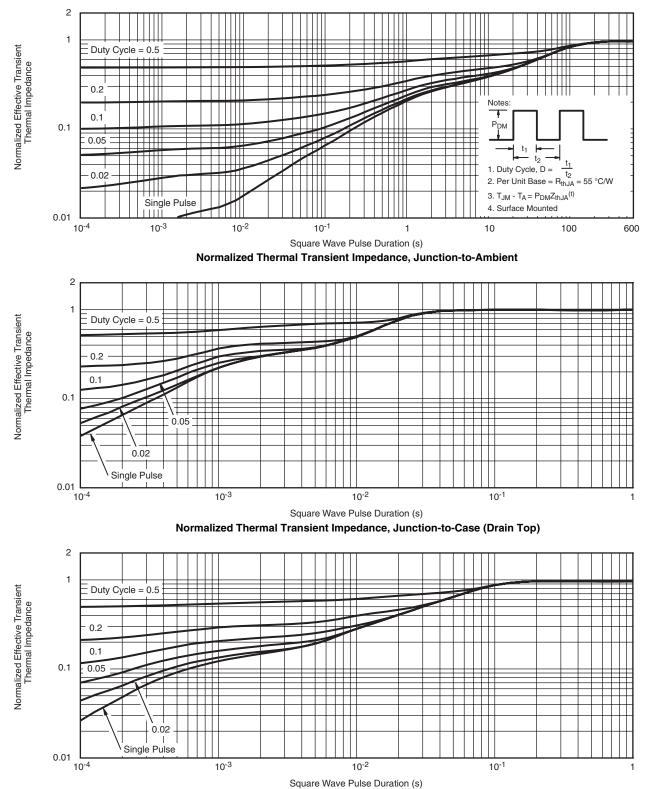
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiE832DF

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



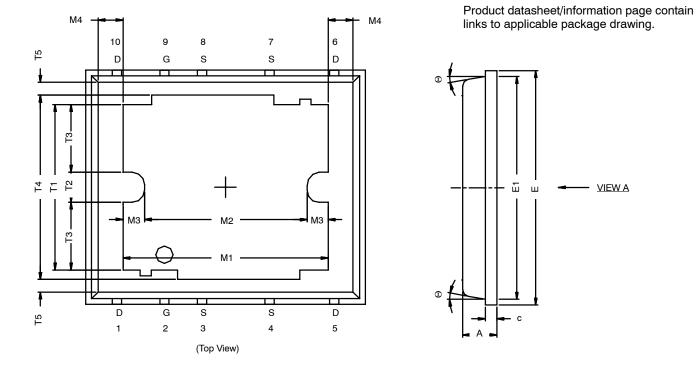
Normalized Thermal Transient Impedance, Junction-to-Source

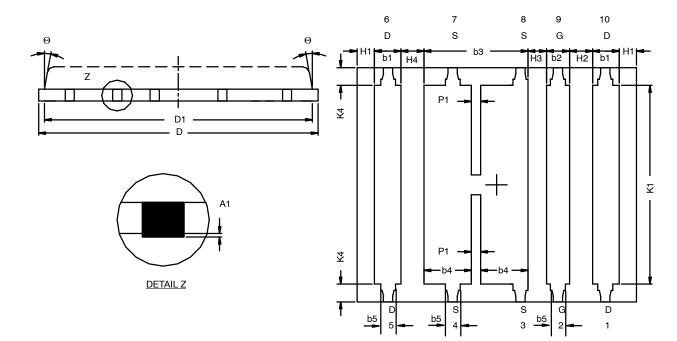
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74414.



Package Information Vishay Siliconix

PolarPAK[™] (Option S)





<u>VIEW A</u> (Bottom View)



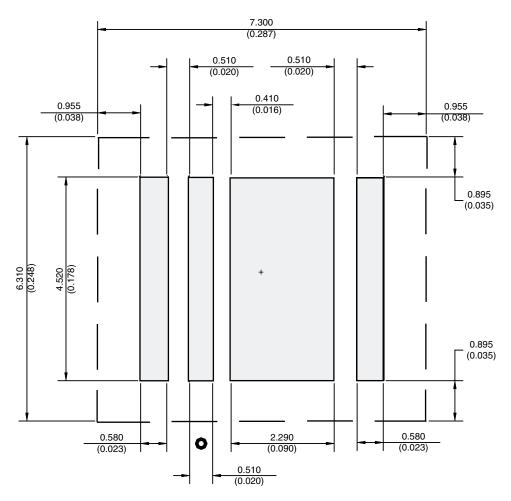
	MI	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max		
Α	0.75	0.80	0.85	0.030	0.031	0.033		
A1	0.00	-	0.05	0.000	-	0.002		
b1	0.48	0.58	0.68	0.019	0.023	0.027		
b2	0.41	0.51	0.61	0.016	0.020	0.024		
b3	2.19	2.29	2.39	0.086	0.090	0.094		
b4	0.89	1.04	1.19	0.035	0.041	0.047		
b5	0.23	0.33	0.43	0.009	0.013	0.017		
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	6.00	6.15	6.30	0.236	0.242	0.248		
D1	5.74	5.89	6.04	0.226	0.232	0.238		
Е	5.01	5.16	5.31	0.197	0.203	0.209		
E1	4.75	4.90	5.05	0.187	0.193	0.199		
H1	0.23	-	-	0.009	-	-		
H2	0.45	-	0.56	0.020	-	0.022		
H3	0.31	0.41	0.51	0.012	0.016	0.020		
H4	0.45	-	0.56	0.020	-	0.022		
K1	4.22	4.37	4.52	0.166	0.172	0.178		
K4	0.24	-	-	0.009	-	-		
M1	4.30	4.50	4.70	0.169	0.177	0.185		
M2	3.43	3.58	3.73	0.135	0.141	0.147		
M3	0.22	-	-	0.009	-	-		
M4	0.05	-	-	0.002	-	-		
P1	0.15	0.20	0.25	0.006	0.008	0.010		
T1	3.48	3.64	4.10	0.137	0.143	0.150		
T2	0.56	0.76	0.95	0.22	0.030	0.037		
Т3	1.20	-	-	0.051	-	-		
T4	3.90	-	-	0.154	-	-		
T5	0	0.18	0.36	0.000	0.007	0.014		
Θ	0°	10°	12°	0°	10°	12°		

Note: Millimeters govern over inches

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RECOMMENDED MINIMUM PADS FOR PolarPAK® Option L and S



Recommended Minimum for PolarPAK Option L and S Dimensions in mm/(Inches) No External Traces within Broken Lines Dot indicates Gate Pin (Part Marking)

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